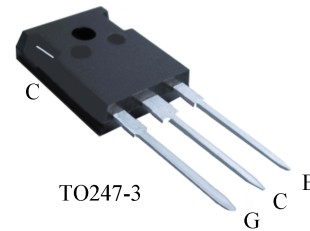
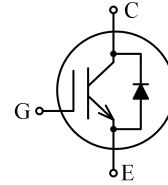


**IGBT in advanced TrenchFS Technology with soft and fast recovery anti-parallel diode**  
具有先进 TrenchFS 技术的 IGBT 且反并联软快恢复二极管

## Features:

### 特性

- 650V TrenchFS technology  
650V 沟槽栅场终止技术
- Low conduction and switching losses  
低导通和开关损耗
- Positive temperature coefficient  
饱和电压正温度系数
- Short Circuit withstand time-5 $\mu$ s  
具备5 $\mu$ s短路承受能力



## Applications:

### 应用

- PFC  
功率因数校正

Type 型号	$V_{CE}$ [V] 集电极-发射极电压	$I_C$ [A] 集电极电流	$V_{CEsat}$ [V] 饱和电压	$T_{jmax}$ [ $^{\circ}$ C] 最高结温	Marking 标记	Package 封装
BGN30T65HD	650	30	1.85	175	30T65HD	TO247-3



## Maximum Rated Values

### 最大额定参数

Parameter 参数	Symbol 符号	Value 值	Unit 单位
Collector-emitter voltage, $T_j \geq 25^\circ\text{C}$ 集电极-发射极电压, $T_j \geq 25^\circ\text{C}$	$V_{CE}$	650	V
Collector current, $T_c = 25^\circ\text{C}$ 集电极电流, $T_c = 25^\circ\text{C}$	$I_C$	60	A
Collector current, $T_c = 100^\circ\text{C}$ 集电极电流, $T_c = 100^\circ\text{C}$	$I_C$	30	
Pulsed collector current, $t_p$ limited by $T_{j\max}$ 集电极脉冲电流, 脉宽时间受 $T_{j\max}$ 限制	$I_{C\text{puls}}$	120	
Diode forward current, $T_c = 25^\circ\text{C}$ 二极管正向电流, $T_c = 25^\circ\text{C}$	$I_F$	30	
Diode forward current, $T_c = 100^\circ\text{C}$ 二极管正向电流, $T_c = 100^\circ\text{C}$	$I_F$	15	
Diode pulsed current 二极管脉冲电流	$I_{F\text{puls}}$	120	
Gate-emitter voltage 栅极-发射极电压	$V_{GE}$	$\pm 20$	V
Short Circuit withstand time $V_{GE} = 15\text{V}, V_{CC} \leq 400\text{V}, T_j \leq 150^\circ\text{C}$ 短路耐受时间	$t_{sc}$	5	us
Total power dissipation, $T_c = 25^\circ\text{C}$ 总耗散功率, $T_c = 25^\circ\text{C}$	$P_{\text{tot}}$	238	W
Operating junction temperature 最高结温	$T_{j\max}$	175	°C
Operating junction temperature 工作结温	$T_{j\text{op}}$	-40...+150	
Storage temperature 储存温度	$T_{\text{stg}}$	-55...+150	
Soldering temperature, 1.6mm from case for 10s 焊接温度	$T_{\text{st}}$	260	
Mounting Torque M3 锁装力矩	$M_d$	0.6	Nm



**Thermal Resistance**

**热阻**

Parameter 参数	Symbol 符号	Value 值	Unit 单位
IGBT Thermal resistance junction to case IGBT 结-管壳热阻	$R_{th(j-c)}$	0.65	$^{\circ}C/W$
Diode Thermal resistance junction to case 二极管结-管壳热阻	$R_{th(j-c)}$	1.69	$^{\circ}C/W$
Thermal resistance junction to ambient 结-环境热阻	$R_{th(j-a)}$	40	$^{\circ}C/W$

**Electrical Characteristic at  $T_j = 25^{\circ}C$  (unless otherwise specified)**

**$T_j=25^{\circ}C$ 时电学特性（除非特别声明）**

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小值	Typ. 典型值	Max. 最大值	

**Static Characteristic**

**静态特性**

Collector-emitter breakdown voltage 集电极-发射极击穿电压	$V_{(BR)CES}$	$V_{GE}=0V,$ $I_C=100\mu A$	650	-	-	V	
Collector-emitter saturation voltage 集电极-发射极饱和电压	$V_{cesat}$	$V_{GE}=15V,$ $I_C=30A$	$T_j=25^{\circ}C$	-	1.85		2.3
			$T_j=150^{\circ}C$	-	2.2		-
Diode forward voltage 二极管正向电压	VF	$V_{GE}=0V,$ $I_F=15A$	$T_j=25^{\circ}C$	-	1.7		2.5
			$T_j=150^{\circ}C$	-	1.4	-	
Gate-emitter threshold voltage 栅极-发射极阈值电压	$V_{GE(th)}$	$I_C=300\mu A,$ $V_{CE}=V_{GE}$	5.0	5.8	7.0		
Collector-emitter cut-off current 集电极-发射极截止电流	$I_{CES}$	$V_{CE}=650V,$ $V_{GE}=0V$	-	-	100	$\mu A$	
Gate-emitter leakage current 栅极-发射极漏电流	$I_{GES}$	$V_{CE}=0V,$ $V_{GE}=\pm 20V$	-200	-	200	nA	

**Dynamic Characteristic**

**动态特性**

Input capacitance 输入电容	$C_{ies}$	$V_{CE}=25V,$ $V_{GE}=0V,$ $f=1MHz$	-	1800	-	pF
Output capacitance 输出电容	$C_{oes}$		-	158	-	
Reverse transfer capacitance 反向传输电容	$C_{res}$		-	51.7	-	



Gate charge 门极电量	$Q_G$	$V_{CC}=400V, I_C=30A,$ $V_{GE}=15V$	-	63.9	-	nC
Short circuit current 短路电流	$I_{C(sc)}$	$V_{CC}=400V, V_{GE}=15V,$ $tpsc \leq 5\mu s, T_j=150^\circ C$	-	120	-	A

Switching Characteristic at  $T_j=25^\circ C$  (Inductive Load)

$T_j=25^\circ C$ 时开关特性 (感性负载)

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小 值	Typ. 典型 值	Max. 最大 值	
<b>IGBT Characteristic</b> <b>IGBT 特性</b>						
Turn-on delay time 开通延迟时间	$t_{d(on)}$	$T_j=25^\circ C,$ $V_{CC}=400V,$ $I_C=30A,$ $V_{GE}=7.5/15V,$ $R_G=10\Omega,$ Energy losses include “tail” and diode reverse recovery.	-	50	-	ns
Rise time 上升时间	$t_r$		-	66	-	
Turn-off delay time 关断延迟时间	$t_{d(off)}$		-	65	-	
Fall time 下降时间	$t_f$		-	16	-	
Turn-on energy 开通损耗	$E_{on}$		-	1.12	-	mJ
Turn-off energy 关断损耗	$E_{off}$		-	0.34	-	
Total switching energy 总开关损耗	$E_{ts}$		-	1.46	-	

Anti-Parallel Diode Characteristic

反并联二极管特性

Reverse recovery time 反向恢复时间	$t_{rr}$	$T_j=25^\circ C,$ $V_R=400V,$ $I_F=15A,$ $diF/dt=390A/\mu s$	-	117	-	ns
Recovered charge 恢复电荷	$Q_r$		-	345	-	nC
Peak reverse recovery current 反向恢复峰值电流	$I_{RM}$		-	5.3	-	A



Switching Characteristic at  $T_j=150^\circ\text{C}$  (Inductive Load)

$T_j=150^\circ\text{C}$ 时开关特性 (感性负载)

Parameter 参数	Symbol 符号	Conditions 条件	Value 值			Unit 单位
			Min. 最小值	Typ. 典型值	Max. 最大值	
<b>IGBT Characteristic</b>						
<b>IGBT 特性</b>						
Turn-on delay time 开通延迟时间	$t_{d(on)}$	$T_j=150^\circ\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=30\text{A}$ , $V_{GE}=-7.5/15\text{V}$ , $R_G=10\Omega$ , Energy losses include "tail" and diode reverse recovery.	-	46	-	ns
Rise time 上升时间	$t_r$		-	62	-	
Turn-off delay time 关断延迟时间	$t_{d(off)}$		-	76	-	
Fall time 下降时间	$t_f$		-	54	-	
Turn-on energy 开通损耗	$E_{on}$		-	1.42	-	mJ
Turn-off energy 关断损耗	$E_{off}$		-	0.59	-	
Total switching energy 总开关损耗	$E_{ts}$	-	2.01	-		

**Anti-Parallel Diode Characteristic**

**反并联二极管特性**

Reverse recovery time 反向恢复时间	$t_{rr}$	$T_j=150^\circ\text{C}$ , $V_R=400\text{V}$ , $I_F=15\text{A}$ , $diF/dt=400\text{A}/\mu\text{s}$	-	152	-	ns
Recovered charge 恢复电荷	$Q_r$		-	980	-	nC
Peak reverse recovery current 反向恢复峰值电流	$I_{RM}$		-	8.7	-	A

## ELECTRICAL CHARACTERISTICS

### 特性曲线

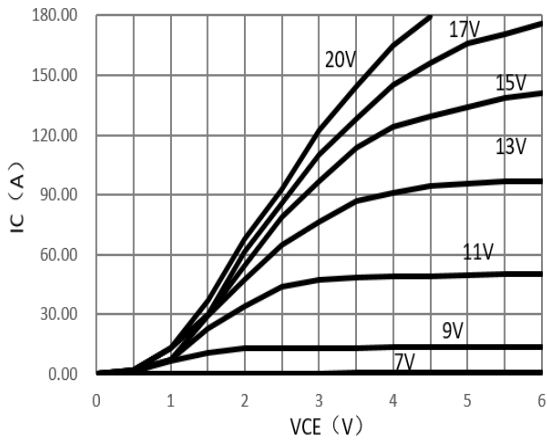


Figure 1. Typical output characteristic( $T_j=25^{\circ}\text{C}$ )

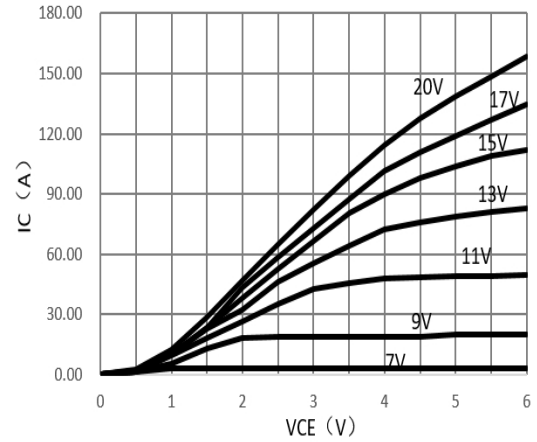


Figure 2. Typical output characteristic( $T_j=150^{\circ}\text{C}$ )

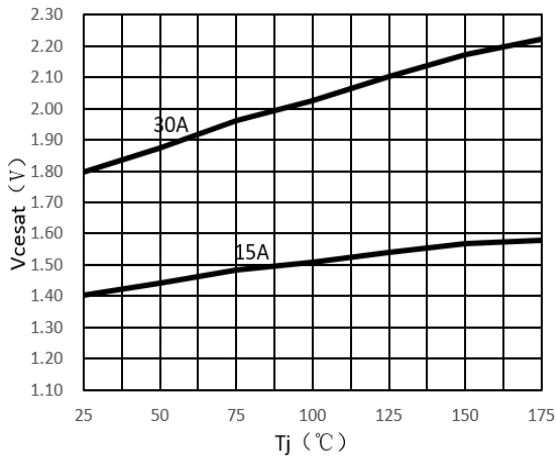


Figure 3.  $V_{\text{cesat}}$  vs.  $T_j$

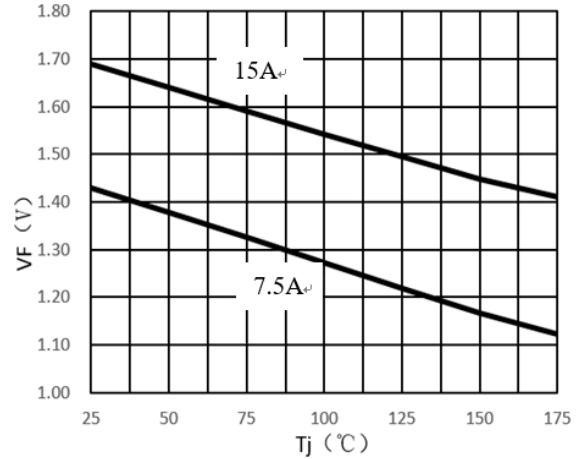


Figure 4.  $V_F$  vs.  $T_j$

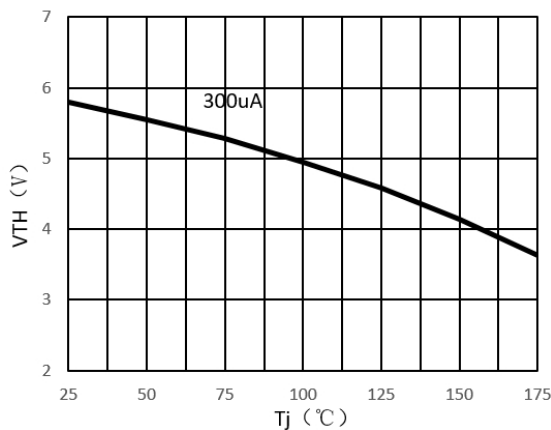


Figure 5.  $V_{\text{TH}}$  vs.  $T_j$

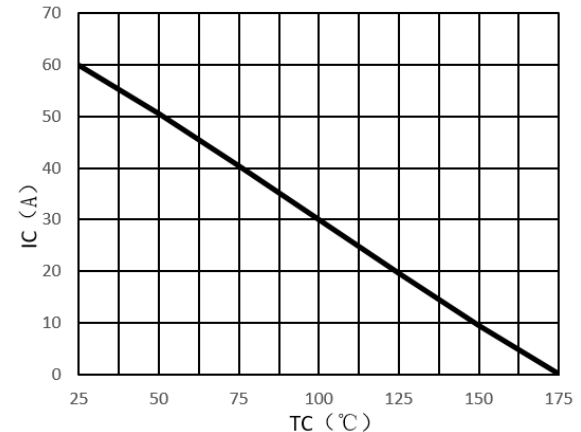


Figure 6.  $I_C$  VS  $T_c$

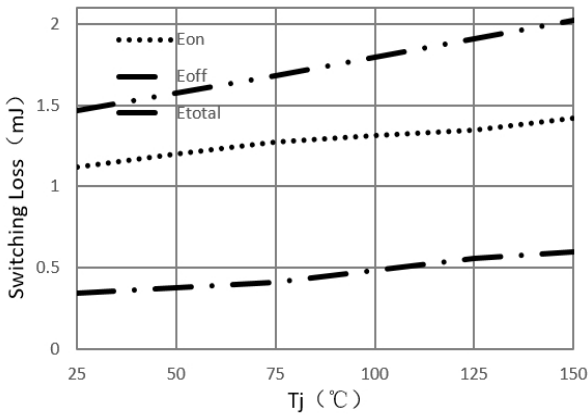


Figure 7. Switching energy losses vs  $T_j$   
( $V_{CE}=400V, V_{GE}=15V, I_C=30A, R_G=10\Omega$ )

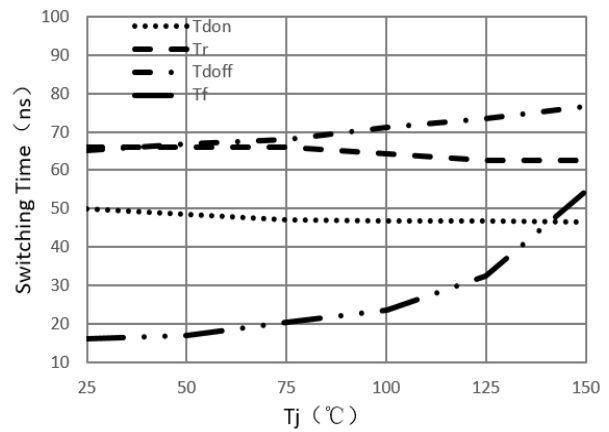


Figure 8. Switching Times vs  $T_j$   
( $T_j=25^\circ C, V_{GE}=15V, I_C=30A, R_G=10\Omega$ )

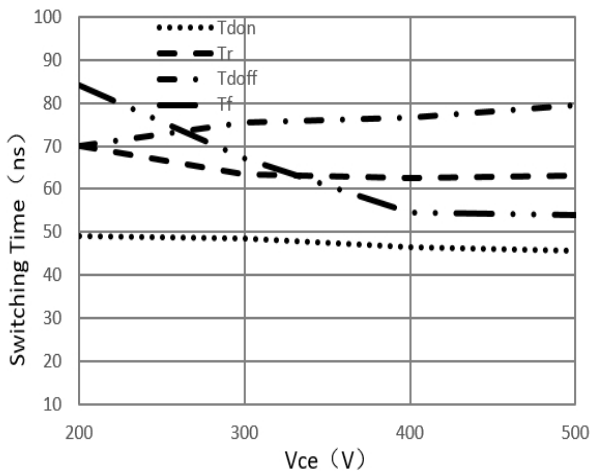


Figure 9. Switching times vs  $V_{CE}$   
( $T_j=150^\circ C, V_{GE}=15V, I_C=30A, R_G=10\Omega$ )

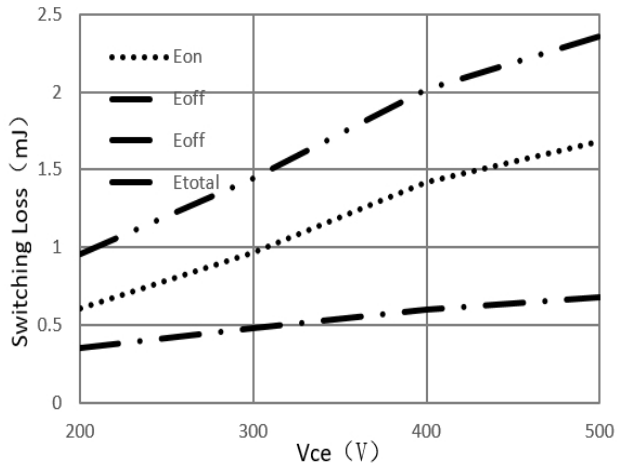


Figure 10. Switching energy losses vs  $V_{CE}$   
( $T_j=150^\circ C, V_{CE}=400V, V_{GE}=15V, I_C=30A$ )

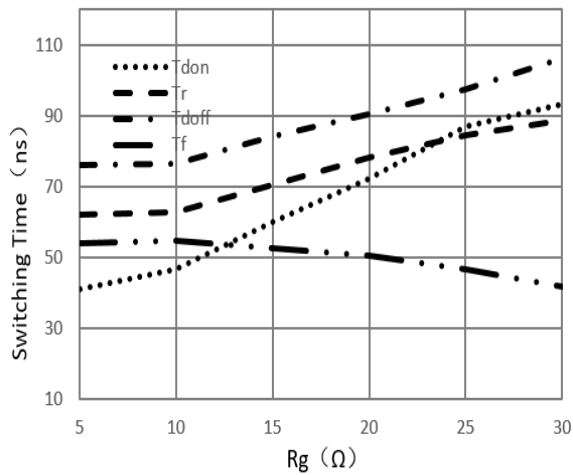


Figure 11. Switching times vs  $R_g$   
( $T_j=150^\circ C, V_{CE}=400V, V_{GE}=15V, I_C=30A$ )

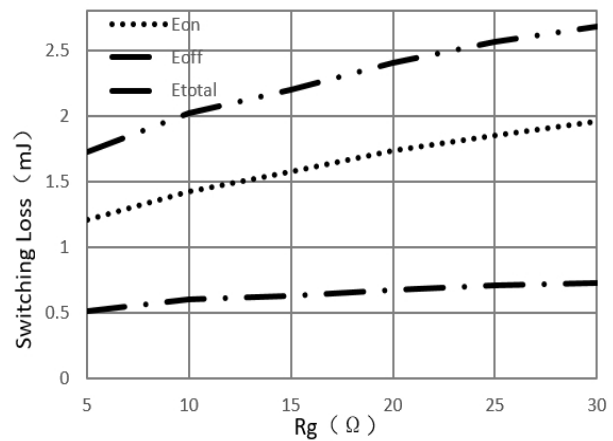
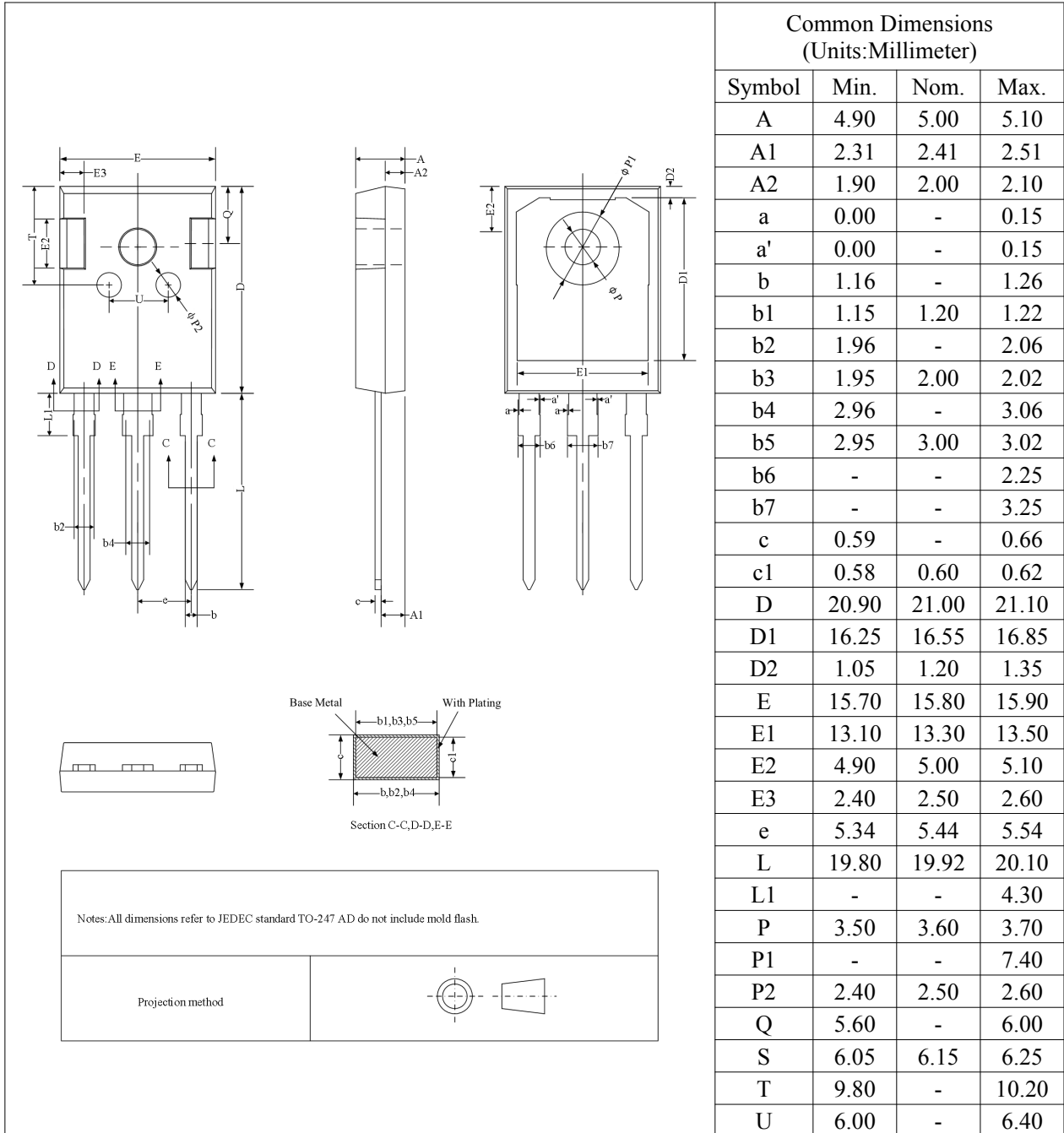


Figure 12. Switching energy losses vs  $R_g$   
( $T_j=150^\circ C, V_{CE}=400V, V_{GE}=15V, I_C=30A$ )



TO247-3 Outline Dimensions:

TO247-3 外形尺寸



Packing

包装

Packing	pcs/tube	tube/ inner box	inner box/ carton	pcs/carton
Tube	30	12	6	2160





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